layer (6), and a polypropylene layer (2) having a melting point above the melting point of the binder, the binder layer (6) being sandwiched between the metal layer or metallized-substrate layer (5) and the polypropylene layer (2), the heat treating being at a temperature below the melting temperature of the polypropylene layer (2), wherein said structure is peelable between binder layer (6) and polypropylene layer (2).

18. (Amended) A structure according to claim 16, wherein said structure comprises polypropylene layers (7, 2) having a melting point above the melting point of the binder, the binder layer (6) being sandwiched between the metal layer or metallized-substrate layer (5) and the polypropylene layer (7, 2), the heat treating being at a temperature below the melting temperature of the polypropylene layer (7, 2).

20. (Amended) A structure according to claim 16, wherein the extrudable binder comprises by weight:

- 5 to 30% of a copolymer (A) based on ethylene and one or more comonomers chosen from the group consisting of carboxylic acid esters, vinyl esters and dienes;
- 40 to 93% of a stretchable polypropylene (B), stretchability being defined as the ability of a rod extruded at a temperature of between 190°C and 240°C and pulled at a pull rate of between 50 and 250 m/min. without breaking;
- 2 to 30% of an additional polypropylene (C) functionalized by an unsaturated carboxylic acid anhydride;
- the MFI of the composition being between 10 and 50 g/10 min. at 230°C/2.16 kg.

21. (Amended) A structure according to claim 20, wherein the copolymer (A) of the binder comprises an ethylene/alkyl (meth)acrylate copolymer containing from 5 to 40% by weight of alkyl (meth)acrylate, the MFI being between 0.5 and 200 g/10 min. at 190°C/2.16 kg.

22. (Amended) A structure according to claim 20, wherein the copolymer (A) of the binder comprises an ethylene/alkyl (meth)acrylate/maleic anhydride copolymer containing from above 0 to 10% by weight of maleic anhydride and from 2 to 40% by weight of alkyl (meth)acrylate, the MFI being between 0.5 and 200 g/10 min. at 190°C/2.16 kg.

23. (Amended) A structure according to claim 20, wherein the copolymer (A) of the binder is a blend of copolymers (A), of an ethylene/alkyl (meth)acrylate copolymer containing 5 to 40% by weight of alkyl (meth)acrylate, and of an ethylene/alkyl (meth)acrylate/maleic anhydride copolymer containing from above 0 to 10% by weight of maleic anhydride and from 2 to 40% by weight of alkyl (meth)acrylate.

24. (Amended) A structure according to claim 20, in which the proportion of polypropylene (C) in the binder is between 1.5 and 6% by weight, said polypropylene (C) containing from 1.5 to 6% by weight of maleic anhydride.

25. (Amended) A structure according to claim 20, in which the proportion of polypropylene (C) in the binder is between 10 and 25% by weight, said polypropylene (C) containing from 0.8 to 1.5% by weight of maleic anhydride.

26. (Amended) A structure according to claim 20, in which the proportion of polypropylene (C) in the binder is between 3 and 5% by weight, said polypropylene (C) containing from 1.5 to 3% by weight of maleic anhydride.

27. (Amended) A cover (4) comprising a structure according to claim 16, in which the metal of the metal or metallized-substrate layer (5) is aluminium.

29. A package made with a structure according to claim 16.

33. (Amended) A process of producing the multi-layer structure of claim 16, comprising the step of extrusion-coating said binder layer at a rate of more than 100 m/min. onto said metal or metallized substrate layer, and heat treating the resultant extrusion coated structure at a temperature above the melting point of the binder layer.

34. (Amended) A process of producing the multi-layer structure of claim 18, comprising the step of extrusion-coating said binder layer at a rate of more than 100 m/min. onto said metal or metallized substrate layer, and heat treating the resultant extrusion coated structure at a

temperature above the melting point of the binder layer, said heat treating being at a temperature below the melting temperature of the polypropylene layer (7, 2).

35. (Amended) A process of producing the multi-layer structure of claim 20, comprising the step of extrusion-coating said binder layer at a rate of more than 100 m/min. onto said metal or metallized substrate layer, and heat treating the resultant extrusion coated structure at a temperature above the melting point of the binder layer.

[Please add new claim 36 as follows:]

--36. **(New)** A structure according to claim 16, wherein said structure is peelable with a peel force for peeling the binder layer (6) off the polypropylene layer (2) of between 8 and 15 N/15 mm.--